

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

SHI-QING WANG, ET AL

Docket: 30-4687 (4780)

Serial Number: 09/328,646

Group Art Unit: 2811

Filed: June 9, 1999

Examiner: H. Vu

For: INTEGRATED CIRCUITS WITH MULTIPLE LOW DIELECTRIC-
CONSTANT INTER-METAL DIELECTRICS

FAX COVER SHEET

TO: Commissioner for Patents
Washington, D.C. 20231

FAX NO.: (703) 308-7722

FROM: Richard S. Roberts
Reg. No. 27941
P.O. Box 484
Princeton, New Jersey 08542
(609) 921-3500

FAX RECEIVED

NOV 14 2002

TECHNOLOGY CENTER 2800

DATE: November 14, 2002

KINDLY DIRECT THIS COMMUNICATION TO:

EXAMINER : H. Vu
GROUP : 2811

NO. OF PAGES SENT INCLUDING THIS COVER SHEET: 16

If all pages are not received, please call (609) 921-3500.

#22/D
76all
1118a

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

SHI-QING WANG, ET AL

Docket: 30-4687 (4780)

Serial Number: 09/328,646

Group Art Unit: 2811

Filed: June 9, 1999

Examiner: Hung K. Vu

For: INTEGRATED CIRCUITS WITH MULTIPLE LOW DIELECTRIC-
CONSTANT INTER- METAL DIELECTRICS

AMENDMENT

FAX RECEIVED

Commissioner for Patents
Washington, D.C. 20231

NOV 14 2002

TECHNOLOGY CENTER 2800

Sir:

In response to the Office Action mailed August 14, 2002, please amend the above identified patent application as follows:

In the claims:

CLEAN COPY OF THE AMENDED CLAIMS

23. (Amended) An integrated circuit structure which comprises a substrate and
(a) an organic layer on a surface of the substrate which comprises a pattern of
metal lines on the substrate and an organic dielectric on the substrate surface
between the metal lines, and wherein the organic dielectric comprises a dielectric
selected from the group consisting of alkoxysilane polymers, organic siloxanes,